

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Brian Taggart et al.

Title: BOND FINGER ON VIA SUBSTRATE, PROCESS OF MAKING SAME, PACKAGE MADE THEREBY, AND METHOD OF ASSEMBLING SAME

Docket No.: 884.853US1

Serial No.: 10/612,281

Filed: June 30, 2003

Due Date: August 30, 2006

Examiner: Jeremy Norris

Group Art Unit: 2841

**MS AF**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

☒ Response Under 37 CFR 1.116 (12 pgs.).

**If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.**

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: /s/   
Atty: .  
Reg. No. 40,362

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)